

tted herewith for filing is the Patent Application of:

🚰: MOU-SHIUNG LIN

WAFER SCALE PACKAGING SCHEME



Enclosed are:

sheets of formal drawing(s).

An assignment of the invention to

An associate power of attorney

Small Entity Status

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)		SMALL ENTITY
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE	>>	>		\$ 395
TOTAL CLAIMS	<b>36 -</b> 20=	16	x )\ e=	\$ 176.
INDEP CLAIMS	<b>5</b> -3=	2	х 41.=	\$ \$ 2 .
MULTIPLE DEPENDENT CLAIM PRESENTED + 260 =				
SUB TOTAL			\$ (Q53.	
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